



DTV1500Mxx

(CRT HORIZONTAL DEFLECTION) HIGH VOLTAGE DAMPER DIODE

MAIN PRODUCTS CHARACTERISTICS

I _{F(AV)}	6 A
V _{RRM}	1500 V
V _{F(max)}	1.65 V
trr (max)	135 ns

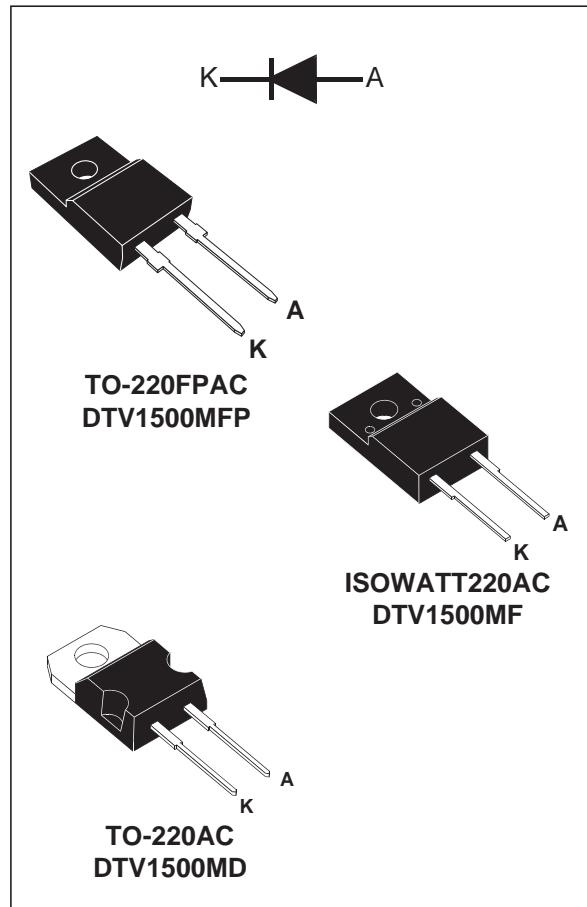
FEATURES AND BENEFITS

- High breakdown voltage capability
- High frequency operation
- Specified turn on switching characteristics
- Very fast recovery diode
- Low static and peak forward voltage drop for low dissipation
- Insulated package (ISOWATT220AC, TO-220FPAC): Insulating voltage = 2000V DC Capacitance = 12pF
- Planar technology allowing high quality and best electrical characteristics

DESCRIPTION

High voltage diode especially designed for horizontal deflection stage in standard and high resolution displays for TV's and monitors.

This device is packaged in TO-220AC, ISOWATT220AC and TO-220FPAC (insulated package).



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{RRM}	Repetitive peak reverse voltage	1500	V
I _{F(RMS)}	RMS forward current	15	A
I _{FSM}	Surge non repetitive forward current tp = 10ms sinusoidal	75	A
T _{stg}	Storage temperature	- 65 to 150	°C
T _j	Maximum operating junction temperature	150	°C

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THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to Case thermal resistance	TO-220FPAC	5.4
		ISOWATT220AC	4.75
		TO-220AC	2.5

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	Value		Unit
			Typ	Max	
I_R *	Reverse leakage current	$V_R = 1500V$	$T_j = 25^\circ C$	100	μA
			$T_j = 125^\circ C$	100	1000
V_F **	Forward voltage drop	$I_F = 6A$	$T_j = 25^\circ C$	1.4	2.2
			$T_j = 125^\circ C$	1.20	1.65

pulse test : * $t_p = 5 \text{ ms}$, $\delta < 2\%$

** $t_p = 380 \mu s$, $\delta < 2\%$

RECOVERY CHARACTERISTICS

Symbol	Parameter	Test Conditions	Value		Unit
			Typ	Max	
t_{rr}	Reverse recovery time	$T_j = 25^\circ C$ $I_F = 1 A$ $dI_F/dt = -50 A/\mu s$ $V_R = 30V$	110	135	ns
t_{rr}	Reverse recovery time	$T_j = 25^\circ C$ $I_F = 100mA$ $I_R = 100mA$ $I_{RR} = 10mA$	750		ns

TURN-ON SWITCHING CHARACTERISTICS

Symbol	Parameter	Test Conditions	Value		Unit
			Typ	Max	
t_{fr}	Forward recovery time	$T_j = 100^\circ C$ $I_F = 6 A$ $dI_F/dt = 80 A/\mu s$ $V_{FR} = 3 V$	570		ns
V_{Fp}	Peak forward voltage	$T_j = 100^\circ C$ $I_F = 6A$ $dI_F/dt = 80 A/\mu s$	21	28	V

To evaluate the maximum conduction losses use the following equation :

$$P = 1.37 \times I_F(AV) + 0.047 \times I_F^2(\text{RMS})$$

Fig. 1: Power dissipation versus peak forward current (triangular waveform, $\delta = 0.45$)

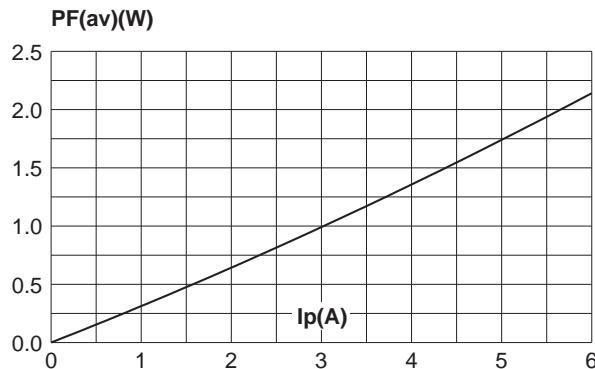


Fig. 2-1: Average current versus case temperature ($\delta = 0.5$) (TO-220FPAC)

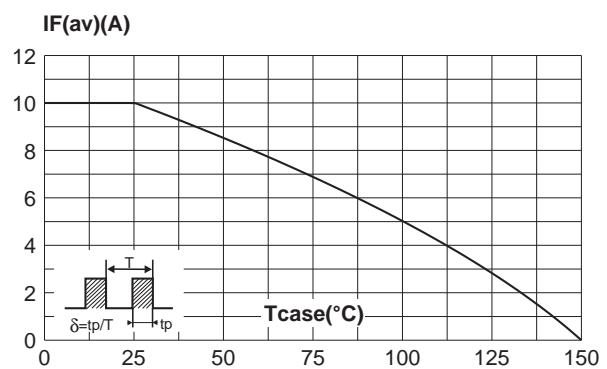


Fig. 2-2: Average current versus case temperature ($\delta = 0.5$) (ISOWATT220AC)

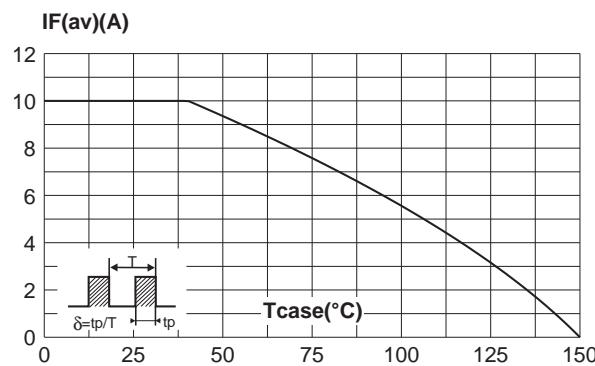


Fig. 2-3: Average current versus case temperature ($\delta = 0.5$) (TO-220AC)

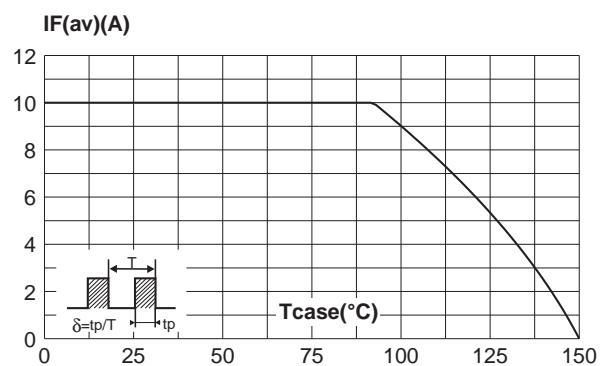


Fig. 3: Forward voltage drop versus forward current (DTV1500MFP/F/D)

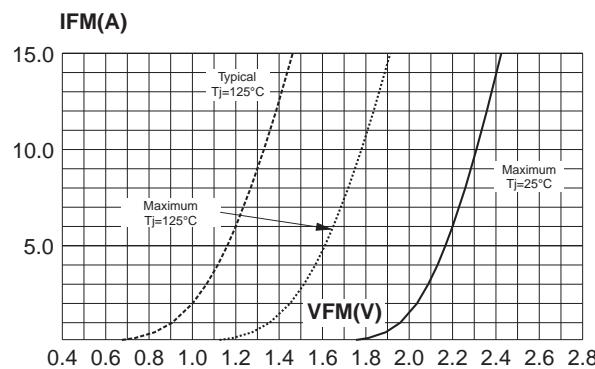
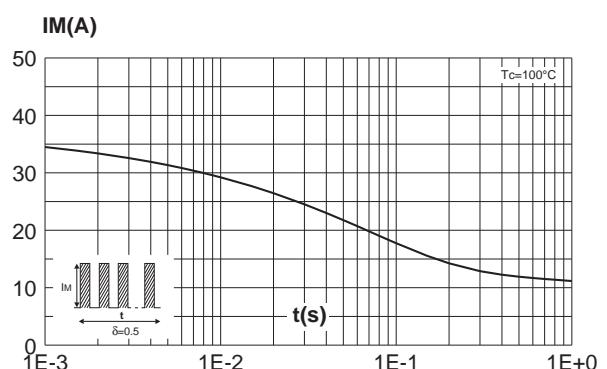


Fig. 4-1: Non repetitive surge peak forward current versus overload duration (TO-220FPAC)



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Fig. 4-2: Non repetitive surge peak forward current versus overload duration (ISOWATT220AC)

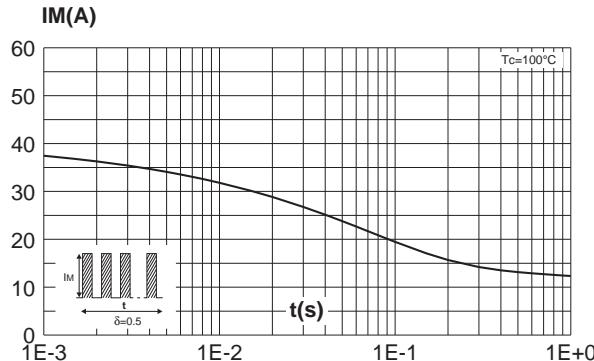


Fig. 4-3: Non repetitive surge peak forward current versus overload duration (TO-220AC)

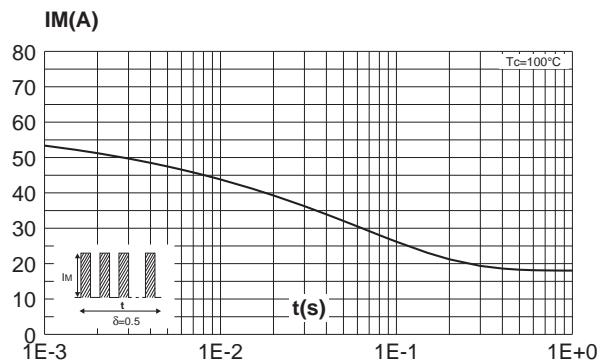


Fig. 5: Reverse recovery charges versus dIF/dt.

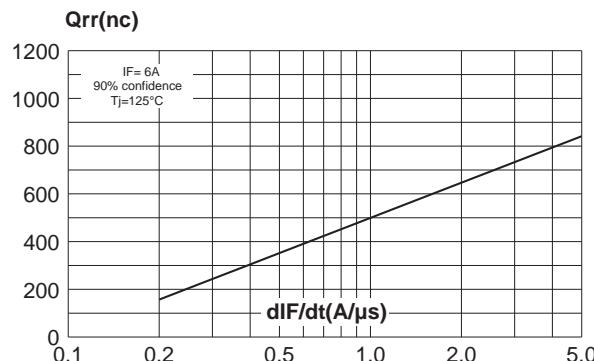


Fig. 6: Reverse recovery current versus dIF/dt.

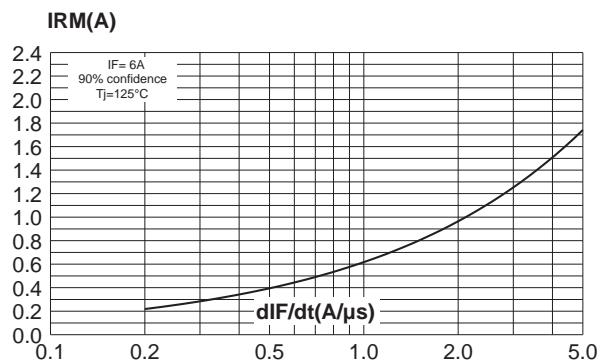


Fig. 7: Transient peak forward voltage versus dIF/dt.

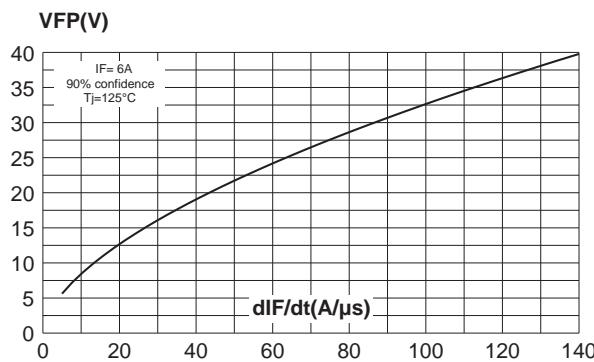


Fig. 8: Forward recovery time versus dIF/dt

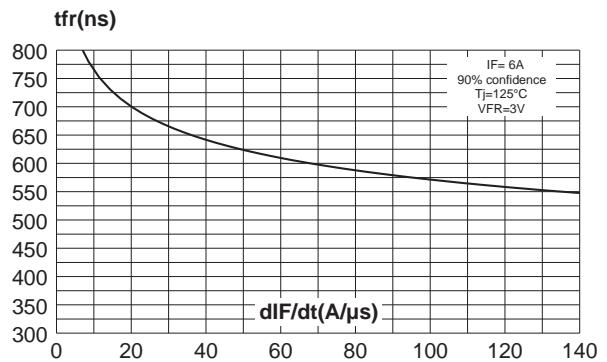


Fig. 9: Dynamic parameters versus junction temperature

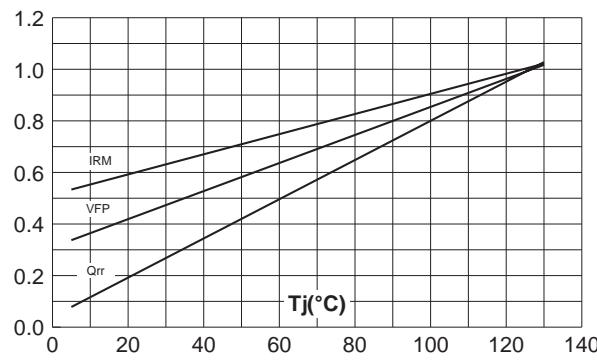


Fig. 10: Junction capacitance versus reverse voltage applied (typical values)

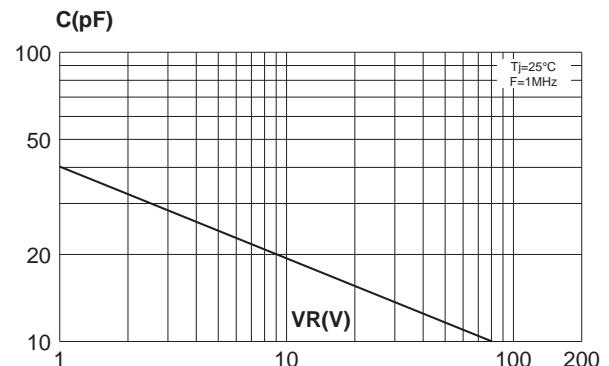


Fig. 11-1: Relative variation of thermal impedance junction to case versus pulse duration (ISOWATT220AC & TO-220FPAC)

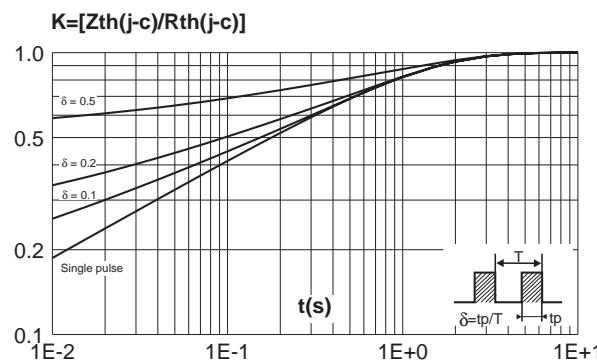
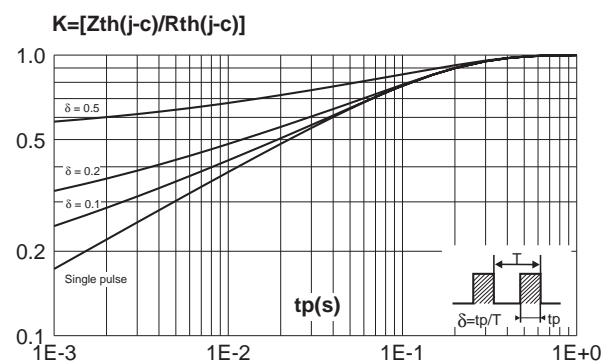


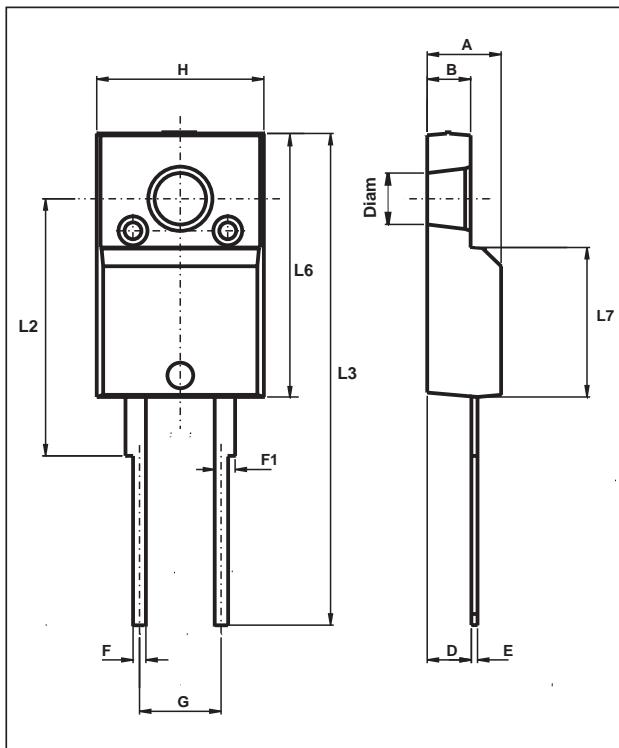
Fig. 11-2: Relative variation of thermal impedance junction to case versus pulse duration (TO-220AC)



PACKAGE DATA
TO-220FPAC

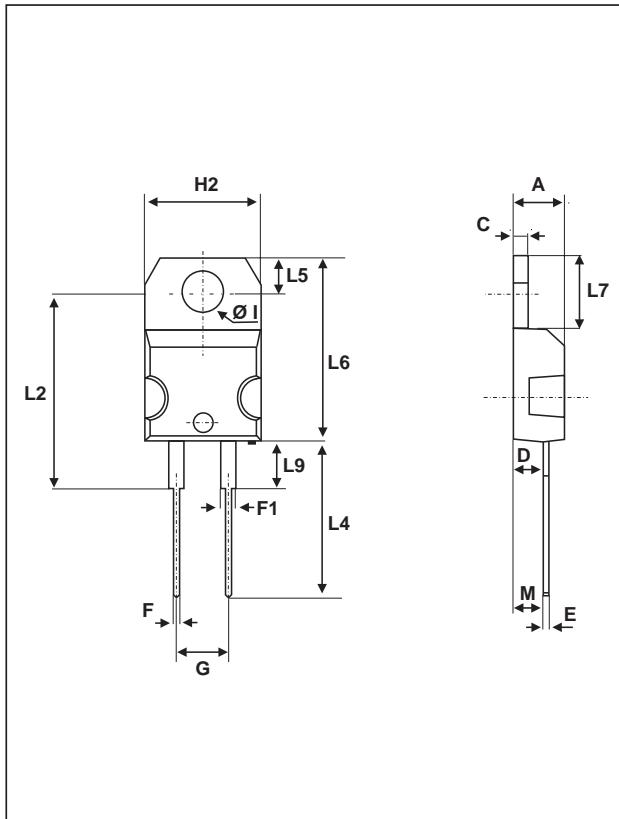
REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.4	4.6	0.173	0.181
B	2.5	2.7	0.098	0.106
D	2.5	2.75	0.098	0.108
E	0.45	0.70	0.018	0.027
F	0.75	1	0.030	0.039
F1	1.15	1.70	0.045	0.067
G	4.95	5.20	0.195	0.205
G1	2.4	2.7	0.094	0.106
H	10	10.4	0.393	0.409
L2	16 Typ.		0.63 Typ.	
L3	28.6	30.6	1.126	1.205
L4	9.8	10.6	0.386	0.417
L5	2.9	3.6	0.114	0.142
L6	15.9	16.4	0.626	0.646
L7	9.00	9.30	0.354	0.366
Dia.	3.00	3.20	0.118	0.126

PACKAGE DATA
 ISOWATT220AC



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
B	2.50	2.70	0.098	0.106
D	2.40	2.75	0.094	0.108
E	0.40	0.70	0.016	0.028
F	0.75	1.00	0.030	0.039
F1	1.15	1.70	0.045	0.067
G	4.95	5.20	0.195	0.205
H	10.00	10.40	0.394	0.409
L2	16.00 Typ.		0.630 Typ.	
L3	28.60	30.60	1.125	1.205
L6	15.90	16.40	0.626	0.646
L7	9.00	9.30	0.354	0.366
Diam	3.00	3.20	0.118	0.126

PACKAGE DATA
 TO-220AC



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
C	1.23	1.32	0.048	0.051
D	2.40	2.72	0.094	0.107
E	0.49	0.70	0.019	0.027
F	0.61	0.88	0.024	0.034
F1	1.14	1.70	0.044	0.066
G	4.95	5.15	0.194	0.202
H2	10.00	10.40	0.393	0.409
L2	16.40 typ.		0.645 typ.	
L4	13.00	14.00	0.511	0.551
L5	2.65	2.95	0.104	0.116
L6	15.25	15.75	0.600	0.620
L7	6.20	6.60	0.244	0.259
L9	3.50	3.93	0.137	0.154
M	2.6 typ.		0.102 typ.	
Diam. I	3.75	3.85	0.147	0.151

Type	Marking	Package	Weight	Base qty	Delivery mode
DTV1500MFP	DTV1500MFP	TO-220FPAC	1.8g	50	Tube
DTV1500MD	DTV1500MD	TO-220AC	1.86g	50	Tube
DTV1500MF	DTV1500MF	ISOWATT220AC	2g	50	Tube

- Cooling method: C
- Epoxy meets UL94-V0
- Torquevalue: 0.55 m.Ntyp (0.7m.Nmax)
- Electrical Isolation: 2000V DC
- Capacitance: 12pF

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